data sheet Colonta INDX 43 / 3MW INDX 43 / 5MW NDT - Filmprocessor







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Colonica INDX 43 / 3MW INDX 43 / 5MW NDT - Filmprocessor

Technical Specifications

Processing applications: Film thickness: Material width: Material length: Rolls/Cut sheets of industrial x-ray films 0,10mm (4mil) - 0,18mm (7mil) min. 7,5 cm max. **43**cm min. 10 cm

Capacities for:	Time in Developer [sec]	Cycle Time (dry to dry) [min]	Intake speed [cm/min]
INDX 43/3MW	32	2' 36"	77
	176	14' 18"	14
INDX 43/5MW	30	2' 08"	115,4
	165	11' 45"	21

additional, see the table on following page.

	Ũ	INDX 43/3MW	INDX 43/5M	IW
Tank capacity -	Developer:	9 L	11L (ir	ncl. DEV-Filter)
	Fixer:	8 L	10L	
	Wash water:	8 L	10L	
Solution heating(Fix and DEV):		adjustable in a range of 18°C - 43°C		
		(separate inline		,
Dryer:		warm air - adjustable in a range of 18°C - 55°C		
Replenishment:		fully automatic.		
		replenishmenti	smicroproces	sor controlled and
		calculated from information received from sensors		
		measuring the width and length of material entering the		
				cles are adjustable.
Wash water distribution:		built in 3-way magnetic valve		
	ash water flow rate: 1,5 -2 ltr/min when film is processed			cessed
Wash water supply pressure: 3 - 10 bar				
Wash water supply: filtered at a temperature of 10°C - 25°C		°C-25°C		
		with 3/4" hose of		
Wash water drain:		32mm (5/4inch	,	
NA7 * 17	– (INDX 43/3MW	INDX 43/5	Technical energification subject
<u>Weight:</u>	Empty	132 kg	150 kg	to change without notice
	With solution	153 kg	179,5 k	g to one go maroar roader

1) Automatic Cooling: The processor electronics will automatically detect over temperature developer conditions and then activate a cold water cooling system. The temperature of the incoming cold water supply should be between 7 - 15 C in order for the system to operate efficiently. If not available and in cases where the processor is required to operate in warm ambient conditions a chiller system should be used on the developer tank solution. A chiller unit is available as an optional accessory from Colenta for either self installation or factory fitted if ordered with the processor.

2) Processor ventilation: The 43I is supplied with an exhaust port located at the feed end of the processor. During installation this port must be connected to an external ventilation system provided at the installation site (sufficient power to ventilate the warm exhaust air away and out of the processing area).

Where the processor is installed in a "through wall" location whereby an auto feeder or feed table is positioned in a darkroom and the main body of the processor is in daylight, it is important that the darkroom is pressurised to ensure a positive airflow from feed to dryer thus avoiding condensation related problems.









